



Micro Commercial Components 20736 Marilla Street Chatsworth CA 91311

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MMDT3946

Features

- Lead Free Finish/RoHS Compliant ("P" Suffix designates RoHS Compliant. See ordering information) Complementary Pari: NPN(3904), PNP(3906)
- Ideal for Low Power Amplification and Switching
- Ultra-small Surface Mount Package
- **Epitaxial Planar Die Construction**
- Marking:K46
- Epoxy meets UL 94 V-0 flammability rating

Moisure Sensitivity Level 1 Maximum Ratings @ 25°C Unless Otherwise Specified

Symbol	Rating	Rating(NPN)	Unit
V_{CEO}	Collector-Emitter Voltage	40	V
V_{CBO}	Collector-Base Voltage	60	V
V_{EBO}	Emitter-Base Voltage	6	V
Ic	Collector Current-Continuous	0.2	Α
Pc	Collector Dissipation	0.2	W
R _{+JA}	Thermal Resistance Junction to Ambient	625	°C\W
TJ	Operating Junction Temperature	-55 to +150	$^{\circ}\mathbb{C}$
T _{STG}	Storage Temperature	-55 to +150	$^{\circ}\mathbb{C}$

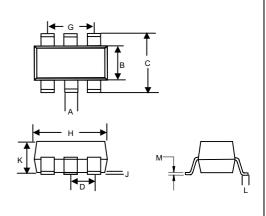
Symbol	Rating	Rating(PNP)	Unit
V_{CEO}	Collector-Emitter Voltage	-40	V
V_{CBO}	Collector-Base Voltage	-40	V
V_{EBO}	Emitter-Base Voltage	-5	V
Ic	Collector Current-Continuous	-0.2	Α
Pc	Collector Dissipation	0.2	W
R ₀ JA	Thermal Resistance Junction to Ambient	625	°C\W
T _J	Operating Junction Temperature	-55 to +150	$^{\circ}\mathbb{C}$
T _{STG}	Storage Temperature	-55 to +150	$^{\circ}\mathbb{C}$



E₁, B₁, C₁ = PNP3906 Section E2, B2, C2 = NPN3904 Section

NPN/PNP **Small Signal Surface Mount Transistors**

SOT-363



DIMENSIONS					
	INC	INCHES		MM	
DIM	MIN	MAX	MIN	MAX	NOTE
Α	.006	.014	0.15	0.35	
В	.045	.053	1.15	1.35	
С	.085	.096	2.15	2.45	
D	.026		0.65Nominal		
G	.047	.055	1.20	1.40	
Н	.071	.087	1.80	2.20	
J		.004		0.10	
K	.035	.043	0.90	1.10	
L	.010	.018	0.26	0.46	
M	.003	.006	0.08	0.15	

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NPN 3904 Electrical Characteristics @ 25°C Unless Otherwise Specified

Symbol	Parameter	Min	Тур	Max	Units
$V_{(BR)CEO}$	Collector-Emitter Breakdown Voltage (I _C =1mAdc, I _B =0)				Vdc
$V_{(BR)CBO}$	Collector-Base Breakdown Voltage (I _C =10uAdc, I _F =0)				Vdc
$V_{(BR)EBO}$	Collector-Emitter Breakdown Voltage (I _F =10uAdc, I _C =0)				Vdc
I _{CBO}	Collector Cutoff Current (V _{CR} =30Vdc,I _F =0)			50	nAdc
I _{CEO}	Collector Cutoff Current (Vc=30Vdc,I _B =0)			500	nAdc
I _{EBO}	Emitter Cutoff Current (V _{EB} =5Vdc,I _C =0)			50	nAdc
h _{FE}	DC Current Gain $ \begin{aligned} &(I_C=0.1\text{mAdc, V}_{CE}=1\text{Vdc}) \\ &(I_C=1\text{mAdc, V}_{CE}=1\text{Vdc}) \\ &(I_C=10\text{mAdc, V}_{CE}=1\text{Vdc}) \\ &(I_C=50\text{mAdc, V}_{CE}=1\text{Vdc}) \\ &(I_C=100\text{mAdc, V}_{CE}=1\text{Vdc}) \end{aligned} $		 	 300 	
$V_{\text{CE(sat)}}$	(I _C =10mAdc, I _B =1mAdc) (I _C =50mAdc, I _B =5mAdc)			0.2 0.3	Vdc
$V_{BE(sat)}$	Base-Emitter Saturation Voltage $(I_C=10 \text{mAdc}, I_B=1 \text{mAdc})$ $(I_C=50 \text{mAdc}, I_B=5 \text{mAdc})$	0.65		0.85 0.95	Vdc
f⊤	Current Gain-Bandwidth Product (V _{CE} =20Vdc, I _C =20mAdc, f=100MHz)	300			MHz
C_{ob}	Output Capacitance (V _{CB} =5Vdc, f=1.0MHz, I _E =0)			4	pF
NF	Noise Figure $(V_{CF}=5V,I_{C}=0.1\text{mA}, f=1\text{KHz}, R_{S}=1\text{k}\Omega)$			5	dB
t _d	Delay Time $V_{CC}=3V$, $I_{C}=10mA$, $V_{BE}=0.5V$,			35	ns
t _r	Rise Time I _{B1} =1mA			35	ns
t _S	Storage Time V _{CC} =3V, I _C =10mA, I _{B1} =I _{B2} =1mA			200	ns
t _f	Fall Time			50	ns

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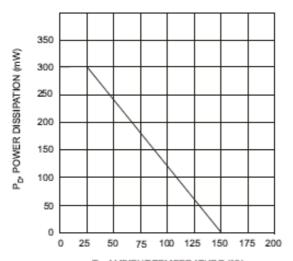


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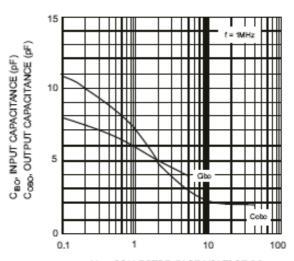
PNP 3906 Electrical Characteristics @ 25°C Unless Otherwise Specified

Symbol	Parameter	Min	Тур	Max	Units
V _{(BR)CEO}	Collector-Emitter Breakdown Voltage	-40			Vdc
V (BR)CEO	$(I_C=-1 \text{mAdc}, I_B=0)$				vac
V _{(BR)CBO}	Collector-Base Breakdown Voltage	-40			Vdc
· (BK)CBO	$(I_C=-10uAdc, I_E=0)$				
$V_{(BR)EBO}$	Collector-Emitter Breakdown Voltage	-5			Vdc
(BR)EBO	(I _E =-10uAdc, I _C =0)				
I _{CBO}	Collector Cutoff Current			-50	nAdc
	(V _{CB} =-30Vdc,I _E =0) Emitter Cutoff Current				
I _{EBO}	$(V_{EB}=-5Vdc,I_{C}=0)$			-50	nAdc
	DC Current Gain				
	$(I_{C}=-0.1 \text{mAdc}, V_{C}=-1 \text{Vdc})$	40			
h _{FE}	$(I_C=-0.11)Adc$, $V_{CE}=-1Vdc$) $(I_C=-1)Adc$, $V_{CE}=-1Vdc$)	70			
1145	(I _C =-11Mdc, V _{CE} =-1Vdc) (I _C =-10mAdc, V _{CE} =-1Vdc)			300	
	(I _C =-50mAdc, V _{CE} =-1Vdc)				
	(I _C =-100mAdc, V _{CE} =-1Vdc)	30			
	Collector-Emitter Saturation Voltage				
$V_{CE(sat)}$	(I _C =-10mAdc, I _B =-1mAdc)			-0.25	Vdc
,	$(I_C=-50 \text{mAdc}, I_B=-5 \text{mAdc})$			-0.4	
	Base-Emitter Saturation Voltage				
$V_{BE(sat)}$	(I _C =-10mAdc, I _B =-1mAdc)			-0.85	Vdc
	$(I_C=-50 \text{mAdc}, I_B=-5 \text{mAdc})$			-0.95	
f⊤	Current Gain-Bandwidth Product	250			MHz
''	(V _{CE} =-20Vdc, I _C =-10mAdc, f=100MHz)	200			1411 12
C_{ob}	Output Capacitance			4.5	рF
- OD	$(V_{CB}=-5Vdc, f=1.0MHz, I_{E}=0)$			4.0	Pi
NF	Noise Figure			4	dB
	$(V_{CE}=-5V,I_{C}=-0.1mA, f=1KHz, R_{S}=1k\Omega)$			•	ű.
t_d	Delay Time V_{CC} =-3V, I_{C} =-10mA, V_{BE} =-0.5V,			35	ns
t _r	Rise Time I _{B1} =-1 _{B2} =-1mA			35	ns
ts	Storage Time V _{CC} =-3V, I _C =-10mA, I _{B1} =-I _{B2} =-1mA			225	ns
t _f	Fall Time			75	ns

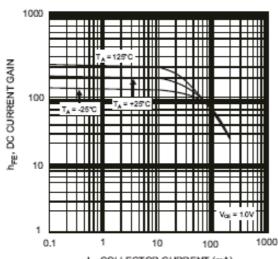
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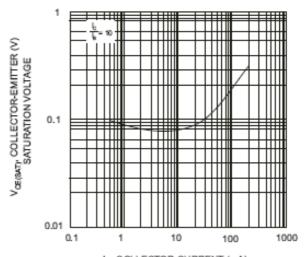
T_A, AMBIENT TEMPERATURE (°C) Fig. 1, Max Power Dissipation vs Ambient Temperature (Total Device)



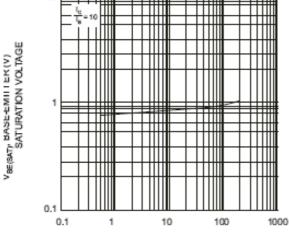
V_{CB}, COLLECTOR-BASE VOLTAGE (V) Fig. 2, Input and Output Capacitance vs. Collector-Base Voltage (NPN-3904)



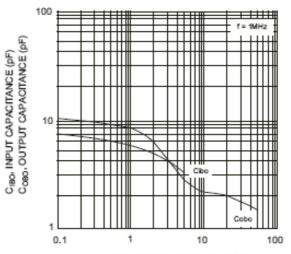
I_C, COLLECTOR CURRENT (mA) Fig. 3, Typical DC Current Gain vs Collector Current (NPN-3904)



I_C COLLECTOR CURRENT (mA) Fig. 4, Typical Collector-Emitter Saturation Voltage vs. Collector Current (NPN-3904)



I_C, COLLECTOR CURRENT (mA)
Fig. 5, Typical Base-Emitter
Saturation Voltage vs. Collector Current (NPN-3904)

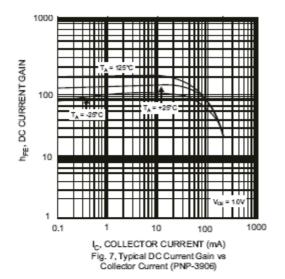


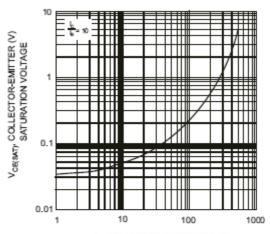
V_{CB}, COLLECTOR-BASE VOLTAGE (V) Fig. 6, Input and Output Capacitance vs. Collector-Base Voltage (PNP-3906)

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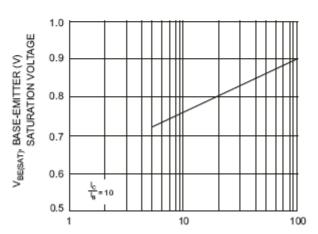


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I_C, COLLECTOR CURRENT (mA)
Fig. 8, Typical Collector-Emitter Saturation Voltage
vs. Collector Current (PNP-3906)



I_C, COLLECTOR CURRENT (mA) Fig. 9, Typical Base-Emitter Saturation Voltage vs. Collector Current (PNP-3906)



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Ordering Information:

Device	Packing
Part Number-TP	Tape&Reel 3Kpcs/Reel

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